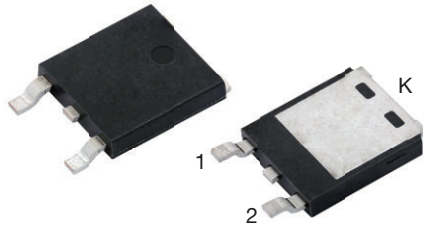
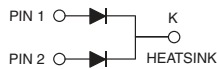


Surface-Mount ESD Capability Rectifier

eSMP® Series



SlimDPAK (TO-252AE)



FEATURES

- Very low profile - typical height of 1.3 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	2 x 2 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_{FSM}	36 A
V_F at $I_F = 2$ A ($T_A = 125$ °C)	0.92 V
T_J max.	175 °C
Package	SlimDPAK (TO-252AE)
Circuit configuration	Common cathode

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102, M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	SE40PWBC	SE40PWDC	SE40PWGC	SE40PWJC	UNIT
Device marking code		SE40PWBC	SE40PWDC	SE40PWGC	SE40PWJC	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum average forward rectified current (fig. 1)	per device $I_{F(AV)}$ (1)	4				A
		2				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	36				A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175				°C

Note

(1) With infinite heatsink



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	$I_F = 1.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.94	-	V
	$I_F = 2.0\text{ A}$			1.01	1.10	
	$I_F = 1.0\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.84	-	
	$I_F = 2.0\text{ A}$			0.92	1.01	
Reverse current	Rated V_R	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	10	μA
		$T_A = 125\text{ }^\circ\text{C}$		12	150	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		t_{rr}	1500	-	ns
Typical junction capacitance	4.0 V, 1 MHz		C_J	14	-	pF

Notes(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	SYMBOL	SE40PWBC	SE40PWDC	SE40PWGC	SE40PWJC	UNIT
Typical thermal resistance per device	$R_{\theta JA}^{(1)(2)}$	63				$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	2.5				

Notes(1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$ (2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient(3) Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS					
$(T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	V_C	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE40PWJC-M3/I	0.20	I	4500	13" diameter plastic tape and reel
SE40PWJCHM3/I ⁽¹⁾	0.20	I	4500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

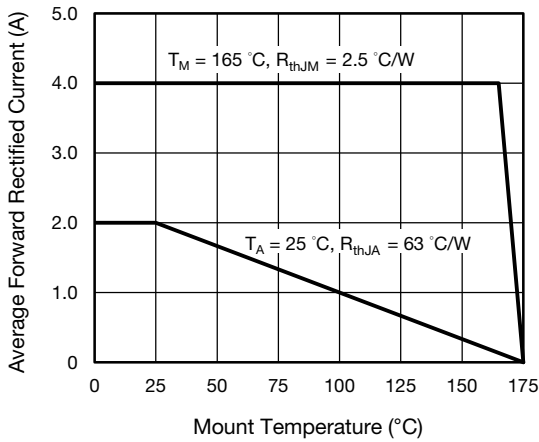


Fig. 1 - Maximum Forward Current Derating Curve

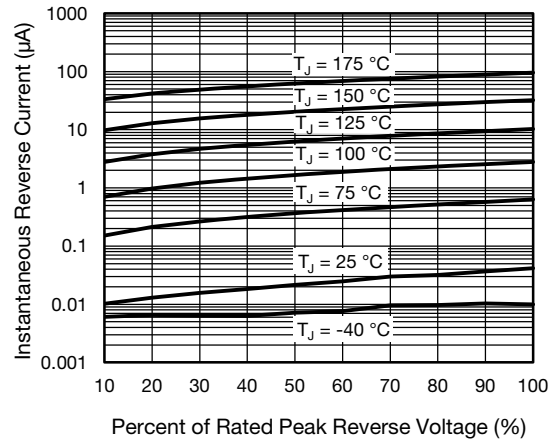


Fig. 4 - Typical Reverse Leakage Characteristics

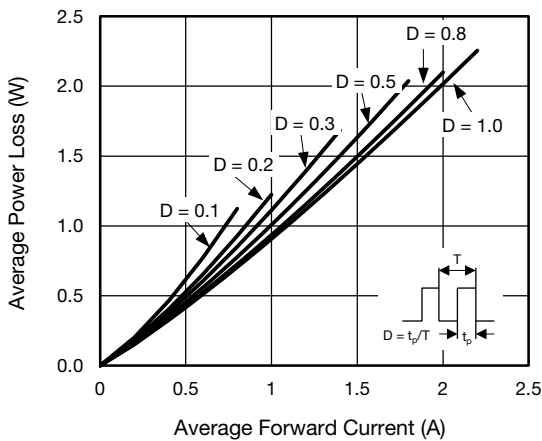


Fig. 2 - Forward Power Loss Characteristics

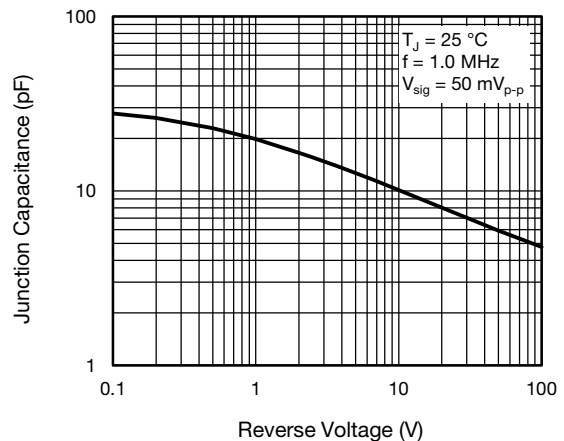


Fig. 5 - Typical Junction Capacitance

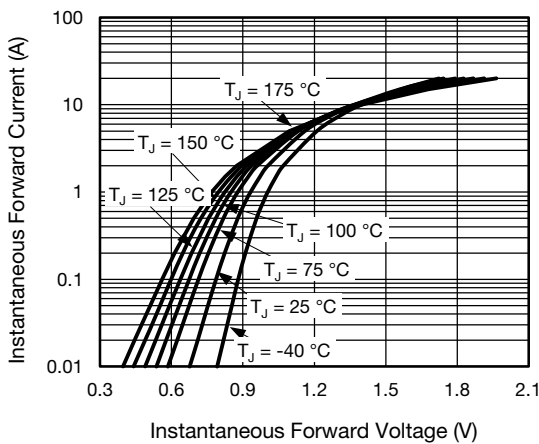


Fig. 3 - Typical Instantaneous Forward Characteristics

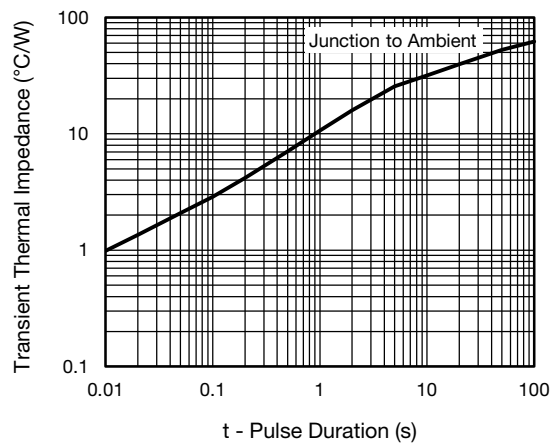
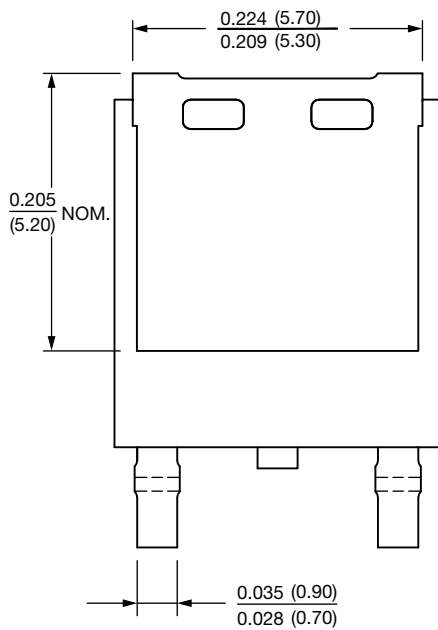
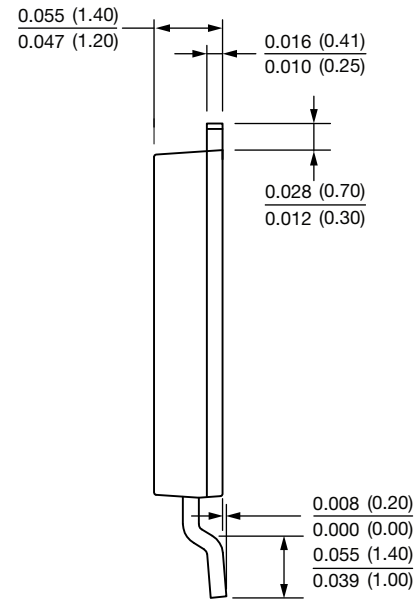
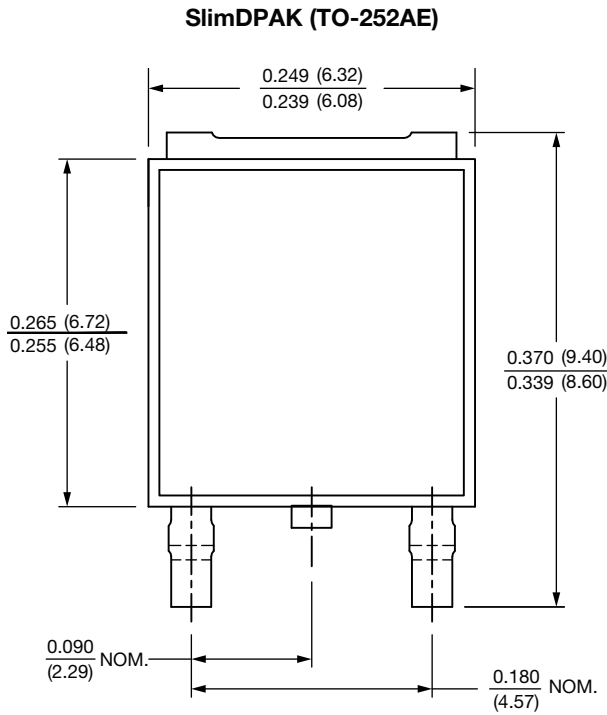


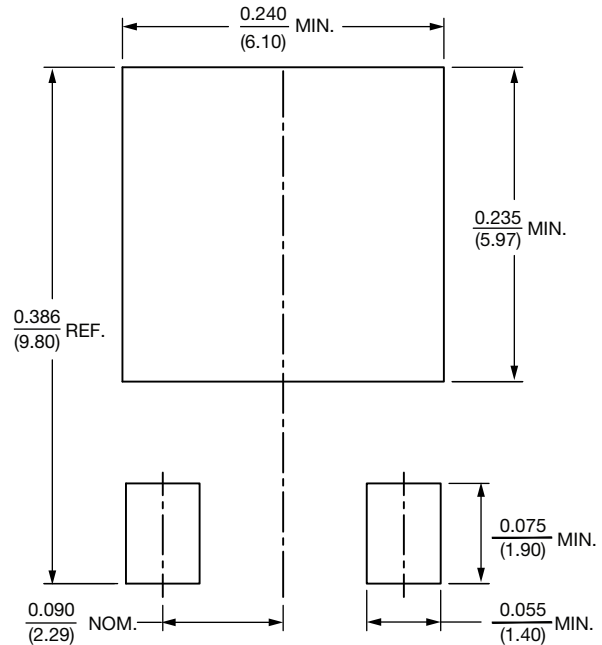
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Mounting Pad Layout





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